



## Application of Diamond Burnishing to Improve the Performance of Materials

Guest Editors:

**Prof. Dr. Jordan Todorov Maximov**

Material Science and Mechanics of Materials, Technical University of Gabrovo, 5300 Gabrovo, Bulgaria

[jordanmaximov@gmail.com](mailto:jordanmaximov@gmail.com)

**Prof. Dr. Galya Velikova Duncheva**

Material Science and Mechanics of Materials, Technical University of Gabrovo, 5300 Gabrovo, Bulgaria

[duncheva@tugab.bg](mailto:duncheva@tugab.bg)

Deadline for manuscript submissions:

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### Message from the Guest Editors

Potential topics include the following:

- Correlation between diamond burnishing (DB) process parameters and surface integrity (SI) characteristics;
- Correlation between the SI characteristics obtained through DB and the operational behavior of the corresponding component (fatigue, wear, corrosion resistance and others);
- Development of novel processes for modifying surface layers based on combining DB with other surface engineering (SE) processes;
- Development and research of novel diamond and other structures as materials for deforming elements in slide burnishing processes;
- DB application for processing complex surfaces and novel materials;
- Development of novel slide burnishing tools and devices and novel strategies for the processing of slide DB deforming elements and tools;
- Exploring the physical nature of slide DB processes:
  - Wear resistance of the deforming element;
  - Friction coefficient between the deforming element and the processed material;
  - Energy exchange in tool–workpiece system.
- Development and application of optimization procedures in slide DB process.





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## Editor-in-Chief

### Prof. Dr. Takayoshi Kobayashi

Advanced Ultrafast Laser  
Research Center, The University  
of Electro-Communications, 1-5-  
1, Chofugaoka, Chofu, Tokyo  
182-8585, Japan

## Message from the Editor-in-Chief

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Applied Sciences  
MDPI, St. Alban-Anlage 66  
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